

L Number	Hits	Search Text	DB	Time stamp
-	5	((("5977624") or ("6150730") or ("6177721") or ("6218731") or ("6252298")).PN.	USPAT	2002/12/15 18:26
-	5	((("5341564") or ("5420460") or ("5578261") or ("5639695") or ("5796586")).PN.	USPAT	2002/12/02 08:28
-	2	((("5677575") or ("5731709")).PN.	USPAT	2002/12/02 08:29
-	19	((("4030309") or ("4664578") or ("4735548") or ("4770590") or ("5011366") or ("5135349") or ("5288199") or ("5311057") or ("5372471") or ("5447409") or ("5468647") or ("5584647") or ("5739585") or ("58118794996587") or ("5583375") or ("5650593") or ("5674785") or ("5677566") or ("5866949") or ("6013946")).PN.	USPAT	2002/12/02 08:37
-	3903	257/666,668.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/02 08:38
-	824	257/777.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/02 08:39
-	2038	257/778,783,784.ccls.	USPAT	2002/12/04 10:37
-	1	"5977624".PN.	USPAT	2002/12/04 09:20
-	1	"6150730".PN.	USPAT	2002/12/04 09:20
-	1	"6177721".PN.	USPAT	2002/12/04 09:20
-	1	"6218731".PN.	USPAT	2002/12/04 09:20
-	32	((("4992849") or ("5151651") or ("5227717") or ("5239198") or ("5258648") or ("5334857") or ("5378981") or ("5483024") or ("5506499") or ("5625221") or ("5668405") or ("5677566") or ("5721496") or ("5731709") or ("5786271") or ("5789271") or ("5789278") or ("5815000") or ("5815372") or ("5844315") or ("5859538") or ("5872458") or ("5883426") or ("5973403") or ("5977784") or ("5994166") or ("6018249") or ("6025725") or ("6049129") or ("6127833") or ("6249052") or ("6335565")).PN.	USPAT	2002/12/04 10:44
-	30	((("4363076") or ("4692943") or ("5148266") or ("5304842") or ("5355283") or ("5466888") or ("5536765") or ("5539251") or ("5548091") or ("5571594") or ("5594282") or ("5600183") or ("5633529") or ("5656862") or ("5659952") or ("5668405") or ("5710071") or ("5733800") or ("5776796") or ("5817545") or ("5818698") or ("6013946") or ("6017776") or ("6048755") or ("6198162") or ("6249052") or ("6252298") or ("6326700") or ("6331453") or ("6175159")).PN.	USPAT	2002/12/04 10:46
-	1075	257/778,783,784.ccls.	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 12:45
-	2	((("5733800") or ("5466888")).PN.	USPAT	2002/12/06 12:22

-	1913	257/687,777,778.ccls.	USPAT	2002/12/06 16:56
-	1	"5677575".PN.	USPAT	2002/12/06 14:35
-	1	"5731709".PN.	USPAT	2002/12/06 14:36
-	641	257/782,783.ccls.	USPAT	2002/12/06 16:57
-	1127	438/15,118.ccls.	USPAT	2002/12/07 12:58
-	1276	438/108,124,127.ccls.	USPAT	2002/12/07 13:08
-	647	438/108,124,127.ccls. and adhesive	USPAT	2002/12/07 13:44
-	3649	COB or chip-on-board	USPAT	2002/12/07 13:44
-	507	(COB or chip-on-board) and (printed adjl circuit adjl board or PCB)	USPAT	2002/12/07 13:46
-	109652	TAB	USPAT	2002/12/11 12:55
-	261	TAB and COB	USPAT	2002/12/11 13:23
-	109	TAB and wire adjl bonding and COB	USPAT	2002/12/11 13:24
-	2401	TAB and wire adjl bonding	USPAT	2002/12/11 13:24
-	2223	(TAB and wire adjl bonding) and (chip or die)	USPAT	2002/12/11 13:25
-	1362	((TAB and wire adjl bonding) and (chip or die)) and (opening or hole)	USPAT	2002/12/11 13:25
-	562	((((TAB and wire adjl bonding) and (chip or die)) and (opening or hole)) and printed adjl circuit adjl board tape adjl automated adjl bonding	USPAT	2002/12/11 13:48
-	3669	tape adjl automated adjl bonding	USPAT	2002/12/11 13:48
-	1598	(tape adjl automated adjl bonding) and wire adjl bonding	USPAT	2002/12/11 13:49
-	1000	((tape adjl automated adjl bonding) and wire adjl bonding) and (hole or opening)	USPAT	2002/12/11 13:49
-	968	((((tape adjl automated adjl bonding) and wire adjl bonding) and (hole or opening)) and (die or chip)	USPAT	2002/12/11 14:14
-	3	(("6133627") or ("5950304") or ("5685885")).PN.	USPAT	2002/12/11 14:16
-	3	(("5347159") or ("5148265") or ("5148266")).PN.	USPAT	2002/12/11 14:45
-	1	("5148266").PN.	USPAT	2002/12/11 14:45
-	5563	computer and DRAM and integrated adjl circuit	USPAT	2002/12/11 15:42
-	1106	(computer and DRAM and integrated adjl circuit) and assembly	USPAT	2002/12/11 15:43
-	62	((computer and DRAM and integrated adjl circuit) and assembly) and semiconductor adjl die	USPAT	2002/12/11 15:43
-	120	epitaxial adjl layer and capacitor and jfet	USPAT	2002/12/11 16:43
-	17397	(resistance or resistivity) and epitaxial	USPAT	2002/12/11 16:43
-	571	((resistance or resistivity) and epitaxial) and JFET	USPAT	2002/12/11 18:33
-	216	"5000" adjl ohm	USPAT	2002/12/11 18:33
-	7	("5000" adjl ohm) and epitaxial	USPAT	2002/12/11 18:33
-	126	"100" adjl ohm and epitaxial	USPAT	2002/12/12 09:22
-	1287	jfet and resistor	USPAT	2002/12/12 09:22
-	185	(jfet and resistor) and epitaxial	USPAT	2002/12/12 09:44

-	1	microphone adj1 condenser and jfet	USPAT	2002/12/12 09:46
-	82	microphone and jfet	USPAT	2002/12/12 09:46
-	562	fillet and tape	USPAT	2002/12/12 11:54
-	39	fillet\$1 and tape and semiconductor adj1 die	USPAT	2002/12/12 12:50
-	676	257/783.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/12 12:51
-	25	257/783.ccls. and fillet\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/12 12:59
-	705	438/118.ccls.	USPAT	2002/12/12 12:59
-	25	438/118.ccls. and fillet\$2	USPAT	2002/12/12 13:03
-	866	(tape or adhesive adj1 layer) and fillet\$2	USPAT	2002/12/12 13:49
-	1	("5784782").PN.	USPAT	2002/12/12 14:15
-	4471	428/209,131,901.ccls.	USPAT	2002/12/12 14:15
-	775	428/209,131,901.ccls. and printed adj1 circuit adj1 board	USPAT	2002/12/12 14:35
-	5847	double adj1 sided near4 tape	USPAT	2002/12/12 14:35
-	25	(double adj1 sided near4 tape) and CTE	USPAT	2002/12/12 14:41
-	0	carrier adj1 film and ahesive adj1 tape	USPAT	2002/12/12 14:41
-	2321	carrier adj1 film	USPAT	2002/12/12 14:42
-	16	(carrier adj1 film) and CTE	USPAT	2002/12/12 14:45
-	1307	(carrier adj1 film) and adhesive	USPAT	2002/12/12 14:46
-	966	((carrier adj1 film) and adhesive) and first and second	USPAT	2002/12/12 14:47
-	410	((carrier adj1 film) and adhesive) and first and second) and thermal	USPAT	2002/12/12 14:52
-	103	carrier adj1 film and thermal adj1 expansion and adhesive	USPAT	2002/12/12 15:48
-	1493	adhesive adj1 film and carrier	USPAT	2002/12/12 15:49
-	146	(adhesive adj1 film and carrier) and thermal adj1 expansion	USPAT	2002/12/12 17:00
-	1378	361/707-712.ccls.	USPAT	2002/12/12 17:13
-	1069	361/719,720,722,723.ccls.	USPAT	2002/12/12 17:15
-	2383	174/52.2,52.4.ccls.	USPAT	2002/12/13 09:44
-	748	174/52.2,52.4.ccls. and (chip or die) and substrate	USPAT	2002/12/13 10:27
-	1016	257/782,783.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/13 10:28
-	501	257/788,789,790.ccls.	USPAT	2002/12/15 15:17
-	21	257/788,789,790.ccls. and glob	USPAT	2002/12/15 15:23
-	280	glob adj1 top and encapsulant	USPAT	2002/12/15 16:37

-	201	257/790.ccls.	USPAT	2002/12/15
-	1	"5216278".PN.	USPAT	16:53
-	1	"5640047".PN.	USPAT	2002/12/15
-	1	"5866949".PN.	USPAT	16:40
-	1	"6013946".PN.	USPAT	2002/12/15
-	1	"6013946".PN.	USPAT	16:41
-	1195	438/124,126,127.ccls.	USPAT	2002/12/15
-	3	((("5612569") or ("5677566") or ("5973337")).PN.	USPAT	16:41
				2002/12/15
				16:54
				2002/12/15
				18:26